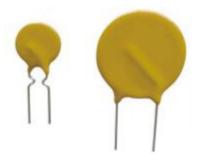


1. Features

- ♦ Radial leaded devices.
- ♦ Over-current protection
- ♦ High voltage surge capabilities
- ♦ Flame retardant epoxy polymer insulating material meets UL94 V-0 requirement.
- ♦ Available in lead-free version.
- ♦ Meets MSL level 1, per J-STD-020
- ♦ Operating Temperature: -40°C~+85°C

2. Applications

- ♦ IT equipment
- ♦ Access network equipment
- ♦ Central office equipment
- ♦ ISDN and xDSL equipments
- ♦ Phone set and fax machine
- ♦ LAN/WAN and VOIP cards

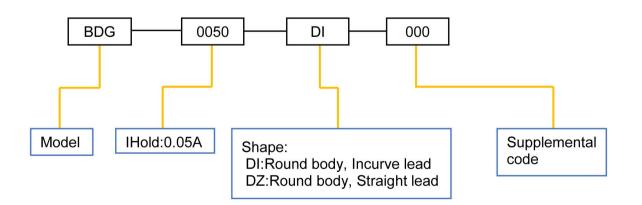


3. Agency Approval

Agency	Agency File Number	Ampere/Voltage Range
c FM °us	E345393	

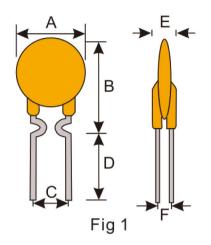
4. Part Number System

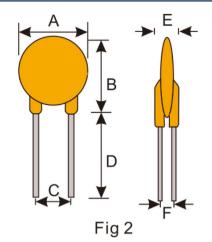
Part num.:BDG0050DI000





5. Size





Model	Style	А	В	С	C D		F	leda
Model		MAX	MAX	Тур	MIN	MAX	Тур	Ф
BDG-003	1	7.4	13.0	5.1 7.6 3.1 0.9		0.9	0.50	
BDG-005	1	7.4	13.0	5.1	7.6	3.1	0.9	0.50
BDG-010	1	7.4	13.0	5.1	7.6	3.1	0.9	0.50
BDG-017	1	7.4	13.0	5.1	5.1 7.6 3.1		0.9	0.50
BDG-017R	1	7.4	13.0	5.1	7.6 3.5		0.9	0.50
BDG-020	1	7.4	13.0	5.1	7.6 3.1		0.9	0.50
BDG-025	1	7.4	13.0	5.1	7.6 3.1		0.9	0.50
BDG-030	1	7.4	13.0	5.1	7.6 3.1		0.9	0.50
BDG-040	1	7.6	13.5	5.1	1 7.6 3.1		0.9	0.50
BDG-050	1	7.9	13.7	5.1	7.6	3.1	0.9	0.50
BDG-065	1	9.4	17.0	5.1	7.6	3.1	1.0	0.60
BDG-075	1	10.2	17.0	5.1	7.6	3.1	1.0	0.60
BDG-090	1	11.2	17.0	5.1	7.6	3.1	1.0	0.60
BDG-110	2	12.8	17.5	5.1	7.6 3.1		1.4	0.80
BDG-135	2	14.5	19.1	5.1	7.6 3.1		1.4	0.80
BDG-160	2	16.3	20.8	5.1	7.6	3.1	1.4	0.80
BDG-185	2	17.5	22.4	5.1	7.6	3.1	1.4	0.80
BDG-200	2	17.5	21.6	5.1	7.6	3.1	1.4	0.80
BDG-250	2	21.0	25.4	10.2	7.6	3.1	1.4	0.78
BDG-300	2	24.5	28.6	10.2	7.6	3.1	1.4	0.78
BDG-375	2	27.2	31.8	10.2	7.6	3.1	1.4	0.78
BDG-500	2	27.2	31.8	10.2	7.6	3.1	1.4	0.78



6. Electrical Characteristics

Model	Vmax	Imax	lhold	Itrip	Pdmax	Max Time Tirp		Resistance	
	(V)	(A)	(A)	(A)	(W)	(A)	(s)	$Rmin(\Omega)$	R1max(Ω)
BDG-003	60/72	40	0.03	0.08	1.00	0.15	10.0	33.0	97.5
BDG-005	60/72	40	0.05	0.10	1.00	0.25	10.0	16.0	39.0
BDG-010	60/72	40	0.10	0.20	1.00	0.50	10.0	2.50	6.75
BDG-017	60/72	40	0.17	0.34	1.00	0.85	10.0	2.00	4.80
BDG-017R	60/72	40	0.17	0.34	1.00	0.85	10.0	3.30	7.82
BDG-020	60/72	40	0.20	0.40	1.00	1.00	10.0	1.50	4.26
BDG-025	60/72	40	0.25	0.50	1.00	1.25	10.0	1.00	2.93
BDG-030	60/72	40	0.30	0.60	1.00	1.50	10.0	0.76	2.04
BDG-040	60/72	40	0.40	0.80	1.00	2.00	10.0	0.52	1.29
BDG-050	60/72	40	0.50	1.00	1.00	2.50	10.0	0.41	1.16
BDG-065	60/72	40	0.65	1.30	1.00	3.25	10.0	0.27	0.72
BDG-075	60/72	40	0.75	1.50	1.00	3.75	10.0	0.18	0.60
BDG-090	60/72	40	0.90	1.80	1.00	4.50	10.0	0.14	0.465
BDG-110	60/72	40	1.10	2.20	1.51	5.50	10.0	0.14	0.375
BDG-135	60/72	40	1.35	2.70	1.71	6.75	10.0	0.12	0.285
BDG-160	60/72	40	1.60	3.20	1.98	8.00	11.4	0.09	0.210
BDG-185	60/72	40	1.85	3.70	2.10	9.25	12.6	0.08	0.180
BDG-200	60/72	40	2.00	4.00	2.20	10.0	11.5	0.05	0.170
BDG-250	60/72	40	2.50	5.00	2.50	12.50	15.6	0.05	0.120
BDG-300	60/72	40	3.00	6.00	2.80	15.00	19.8	0.04	0.090
BDG-375	60/72	40	3.75	7.50	3.20	18.75	24.0	0.03	0.075
BDG-500	60/72	40	5.00	10.0	3.20	20.00	30.0	0.03	0.075

7. Parameter interpretation

- ♦ IH = Hold current: maximum current device will pass without tripping in 25°C still air.
- ♦ IT = Trip current: minimum current at which the device will trip in 25°C still air.
- ♦ VMAX = Maximum voltage device can withstand without damage at rated current.
- → IMAX = Maximum fault current device can withstand without damage at rated voltage.
- ♦ RMAX = Maximum resistance of device in initial (un-soldered) state.
- ♦ RMIN = Minimum resistance of device in initial (un-soldered) state.
- ♦ Pd typ. = Typical power dissipation from device when in the tripped state at 25°C still air.



8. Polymeric PTC selecting guide

- Determine the following operating parameters for the circuits:
 - Normal operating current (Ihold)
 - Maximum interrupt current (Imax)
 - Maximum circuit voltage (Vmax)
 - Normal operating temperature surrounding device (min°C/max°C)
- ♦ Select the device from factor and dimension suitable for the application
- ♦ Compare the maximum rating for Vmax and Imax of the PPTC device with the circuit in application and make sure the circuit's requirement does not exceed the device rating.
- ♦ Check that PPTC device's trip time (time-to-trip) will protect the circuit.
- ♦ Verify that the circuit operating temperature is within the PPTC device's normal operating temperature range.
- Verify that performance and suitability of the chosen PPTC device in the application.

9. Warning

♦ Mechanical Stress

• PPTC devices will undergo a thermal expansion during fault condition. If PPTC devices are installed or placed in an application where the space between PPTC devices and the surrounding materials (e.g., covering materials, packaging materials, encapsulate materials and the like) is insufficient, it will cause an inhibiting effect upon the thermal expansion. Pressing, twisting, bending and other kinds of mechanical stress will also adversely affect the performance of the PPTC devices, and shall not be used or applied.

Chemical Pollutants

 Silicone-based oils, oils, solvents, gels, electrolytes, fuels, acids, and the like will adversely affect the properties of PPTC devices, and shall not be used or applied.

♦ Electronic and Thermal Effect

- PPTC devices are secondary protection devices and are used solely for sporadic, accidental over-current or over-temperature error condition, and shall NOT be used if or when constant or repeated fault conditions (such fault conditions may be caused by, among others, incorrect pin-connection of a connector) or over-extensive trip events may occur.
- PPTC devices are different from fuses and, when a fault condition occurs, will go into high-resistance state and do
 not open circuit, in which case the voltage at such PPTC devices may reach a hazardous level.
- Operation over the maximum rating or other forms of improper use may cause failure, arcing, flame and/or other damage to the PPTC devices.
- Conductive material contamination, such as metal particle, may induce shortage, flame or arcing.
- Due to the inductance, the operation circuits may generate a circuit voltage (Ldi/dt) above the rated voltage of PPTC devices, which shall not be used under such circumstances.

♦ General

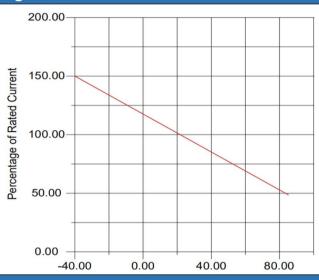
- Customers shall evaluate and test the properties of PPTC devices independently to verify and ensure that their individual applications will be met.
- The performance of PPTC devices will be adversely affected if they are improperly used under electronic, thermal



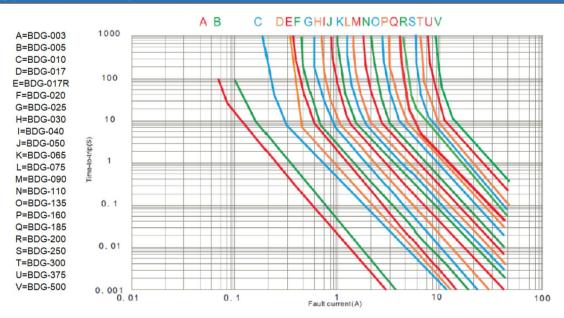
and/or mechanical procedures and/or conditions non-conformant to those recommended by manufacturer.

- Customers shall be responsible for determining whether it is necessary to have back-up, failsafe and/or fool-proof
 protection to avoid or minimize damage that may result from extra-ordinary, irregular function or failure of PPTC
 devices.
- Any and all responsibilities and liabilities are disclaimed if any item under this notice of warning is not complied with.

10. Thermal derating curve



11. Typical time-to-trip at $25\% \pm 2\%$



12. Storage recommendations

- ♦ Storage Temperature: -10°C~+40°C
- ♦ Relative Humidity: ≤80%RH
- ♦ Keep away from corrosive atmosphere and sunlight.
- ♦ Period of Storage: 1 year.